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PATENT

1-15-03
P. Spruell

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 09/829,161

Filed: April 9, 2001

For: METALLIZATION STRUCTURES
FOR SEMICONDUCTOR DEVICE
INTERCONNECTS, METHODS FOR
MAKING SAME, AND
SEMICONDUCTOR DEVICES
INCLUDING SAME

Confirmation No.: 8260

Examiner: H. Nguyen

Group Art Unit: 2812

Attorney Docket No.: 3442.1US (96-428.1)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

January 7, 2003
Date


Signature

Leah Barrow
Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits. Applicant notes that this Supplemental Information Disclosure Statement was previously filed on October 16, 2002. Applicant has again filed the Supplemental Information Statement, and requests that a copy of Form PTO/SB/08 be initialed by the Examiner and returned to Applicant's undersigned attorney. Also, the fee pursuant to 37 C.F.R. § 1.117(p) is enclosed.

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In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08 be considered by the Examiner and made of record. The listed documents were cited by the office in co-pending application Serial No. 09/388,031, filed September 1, 1999, and directed to a related invention. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

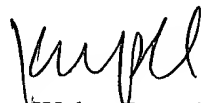
<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 5,985,762	11/16/1999	Geffken et al.
US - 6,255,734 B1	07/03/2001	Liu et al.

Applicant offers to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

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If the fee pursuant to 37 C.F.R. § 1.117(p) is not needed or if additional fees are required, the Commissioner is authorized to credit or charge any such fees to TraskBritt Deposit Account No. 20-1469.

Respectfully submitted,



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Date: January 7, 2003

KWP/hlg:lb

Enclosures: Form PTO/SB/08

Copy of documents cited

Check No. 3531 in the amount of \$180.00

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